

# IRF5805PbF

HEXFET® Power MOSFET

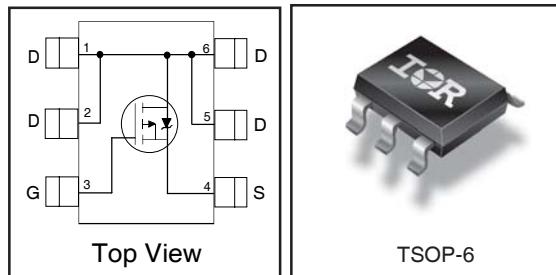
| <b>V<sub>DSS</sub></b> | <b>R<sub>DS(on)</sub> max</b> | <b>I<sub>D</sub></b> |
|------------------------|-------------------------------|----------------------|
| <b>-30V</b>            | 0.098@V <sub>GS</sub> = -10V  | -3.8A                |
|                        | 0.165@V <sub>GS</sub> = -4.5V | -3.0A                |

- Ultra Low On-Resistance
- P-Channel MOSFET
- Surface Mount
- Available in Tape & Reel
- Low Gate Charge
- Lead-Free
- Halogen-Free

## Description

These P-channel MOSFETs from International Rectifier utilize advanced processing techniques to achieve the extremely low on-resistance per silicon area. This benefit provides the designer with an extremely efficient device for use in battery and load management applications.

The TSOP-6 package with its customized leadframe produces a HEXFET® power MOSFET with R<sub>DS(on)</sub> 60% less than a similar size SOT-23. This package is ideal for applications where printed circuit board space is at a premium. It's unique thermal design and R<sub>DS(on)</sub> reduction enables a current-handling increase of nearly 300% compared to the SOT-23.



## Absolute Maximum Ratings

|                                        | Parameter                                        | Max.         | Units |
|----------------------------------------|--------------------------------------------------|--------------|-------|
| V <sub>DS</sub>                        | Drain-Source Voltage                             | -30          | V     |
| I <sub>D</sub> @ T <sub>A</sub> = 25°C | Continuous Drain Current, V <sub>GS</sub> @ -10V | -3.8         | A     |
| I <sub>D</sub> @ T <sub>A</sub> = 70°C | Continuous Drain Current, V <sub>GS</sub> @ -10V | -3.0         |       |
| I <sub>DM</sub>                        | Pulsed Drain Current①                            | -15          |       |
| P <sub>D</sub> @ T <sub>A</sub> = 25°C | Maximum Power Dissipation③                       | 2            | W     |
| P <sub>D</sub> @ T <sub>A</sub> = 70°C | Maximum Power Dissipation③                       | 1.28         | W     |
|                                        | Linear Derating Factor                           | 0.02         | W/°C  |
| V <sub>GS</sub>                        | Gate-to-Source Voltage                           | ± 20         | V     |
| T <sub>J</sub> , T <sub>STG</sub>      | Junction and Storage Temperature Range           | -55 to + 150 | °C    |

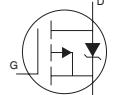
## Thermal Resistance

|                  | Parameter                    | Max. | Units |
|------------------|------------------------------|------|-------|
| R <sub>0JA</sub> | Maximum Junction-to-Ambient③ | 62.5 | °C/W  |

**Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

|                                               | Parameter                            | Min. | Typ. | Max.  | Units                     | Conditions                                                                             |
|-----------------------------------------------|--------------------------------------|------|------|-------|---------------------------|----------------------------------------------------------------------------------------|
| $V_{(\text{BR})\text{DSS}}$                   | Drain-to-Source Breakdown Voltage    | -30  | —    | —     | V                         | $V_{\text{GS}} = 0\text{V}$ , $I_D = -250\mu\text{A}$                                  |
| $\Delta V_{(\text{BR})\text{DSS}}/\Delta T_J$ | Breakdown Voltage Temp. Coefficient  | —    | 0.02 | —     | $\text{V}/^\circ\text{C}$ | Reference to $25^\circ\text{C}$ , $I_D = -1\text{mA}$                                  |
| $R_{\text{DS}(\text{on})}$                    | Static Drain-to-Source On-Resistance | —    | —    | 0.098 | $\Omega$                  | $V_{\text{GS}} = -10\text{V}$ , $I_D = -3.8\text{A}$ ②                                 |
|                                               |                                      | —    | —    | 0.165 |                           | $V_{\text{GS}} = -4.5\text{V}$ , $I_D = -3.0\text{A}$ ②                                |
| $V_{\text{GS}(\text{th})}$                    | Gate Threshold Voltage               | -1.0 | —    | -2.5  | V                         | $V_{\text{DS}} = V_{\text{GS}}$ , $I_D = -250\mu\text{A}$                              |
| $g_{\text{fs}}$                               | Forward Transconductance             | 3.5  | —    | —     | S                         | $V_{\text{DS}} = -10\text{V}$ , $I_D = -3.8\text{A}$                                   |
| $I_{\text{DSS}}$                              | Drain-to-Source Leakage Current      | —    | —    | -15   | $\mu\text{A}$             | $V_{\text{DS}} = -24\text{V}$ , $V_{\text{GS}} = 0\text{V}$                            |
|                                               |                                      | —    | —    | -25   |                           | $V_{\text{DS}} = -24\text{V}$ , $V_{\text{GS}} = 0\text{V}$ , $T_J = 70^\circ\text{C}$ |
| $I_{\text{GSS}}$                              | Gate-to-Source Forward Leakage       | —    | —    | -100  | nA                        | $V_{\text{GS}} = -20\text{V}$                                                          |
|                                               | Gate-to-Source Reverse Leakage       | —    | —    | 100   |                           | $V_{\text{GS}} = 20\text{V}$                                                           |
| $Q_g$                                         | Total Gate Charge                    | —    | 11   | 17    | nC                        | $I_D = -3.8\text{A}$                                                                   |
| $Q_{\text{gs}}$                               | Gate-to-Source Charge                | —    | 2.3  | —     |                           | $V_{\text{DS}} = -15\text{V}$                                                          |
| $Q_{\text{gd}}$                               | Gate-to-Drain ("Miller") Charge      | —    | 1.5  | —     |                           | $V_{\text{GS}} = -10\text{V}$                                                          |
| $t_{\text{d}(\text{on})}$                     | Turn-On Delay Time                   | —    | 11   | 17    | ns                        | $V_{\text{DD}} = -15\text{V}$ , $V_{\text{GS}} = -10\text{V}$                          |
| $t_r$                                         | Rise Time                            | —    | 14   | 21    |                           | $I_D = -1.0\text{A}$                                                                   |
| $t_{\text{d}(\text{off})}$                    | Turn-Off Delay Time                  | —    | 90   | 135   |                           | $R_G = 6.0\Omega$                                                                      |
| $t_f$                                         | Fall Time                            | —    | 49   | 74    |                           | $R_D = 15\Omega$ ②                                                                     |
| $C_{\text{iss}}$                              | Input Capacitance                    | —    | 511  | —     | pF                        | $V_{\text{GS}} = 0\text{V}$                                                            |
| $C_{\text{oss}}$                              | Output Capacitance                   | —    | 79   | —     |                           | $V_{\text{DS}} = -25\text{V}$                                                          |
| $C_{\text{rss}}$                              | Reverse Transfer Capacitance         | —    | 50   | —     |                           | $f = 1.0\text{MHz}$                                                                    |

**Source-Drain Ratings and Characteristics**

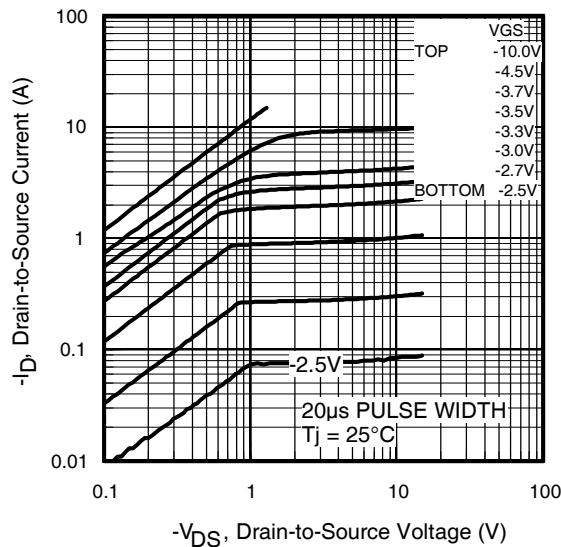
|                 | Parameter                              | Min. | Typ. | Max. | Units | Conditions                                                                            |
|-----------------|----------------------------------------|------|------|------|-------|---------------------------------------------------------------------------------------|
| $I_S$           | Continuous Source Current (Body Diode) | —    | —    | -2.0 | A     | MOSFET symbol showing the integral reverse p-n junction diode.                        |
| $I_{\text{SM}}$ | Pulsed Source Current (Body Diode) ①   | —    | —    | -15  |       |  |
| $V_{\text{SD}}$ | Diode Forward Voltage                  | —    | —    | -1.2 | V     | $T_J = 25^\circ\text{C}$ , $I_S = -2.0\text{A}$ , $V_{\text{GS}} = 0\text{V}$ ②       |
| $t_{rr}$        | Reverse Recovery Time                  | —    | 19   | 29   | ns    | $T_J = 25^\circ\text{C}$ , $I_F = -2.0\text{A}$                                       |
| $Q_{rr}$        | Reverse Recovery Charge                | —    | 16   | 24   | nC    | $dI/dt = -100\text{A}/\mu\text{s}$ ②                                                  |

**Notes:**

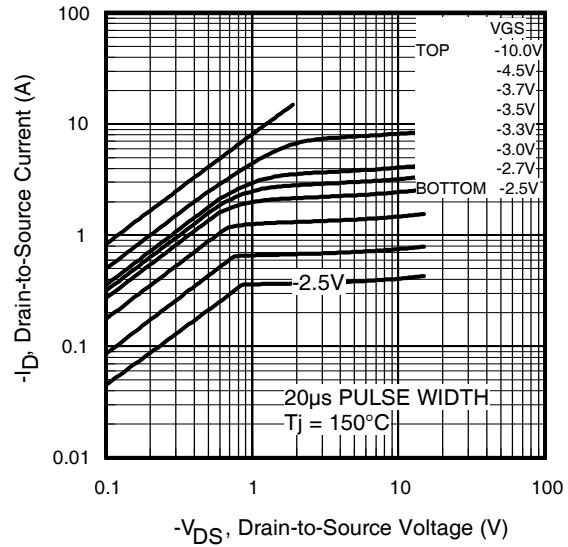
① Repetitive rating; pulse width limited by max. junction temperature.

② Pulse width  $\leq 400\mu\text{s}$ ; duty cycle  $\leq 2\%$ .

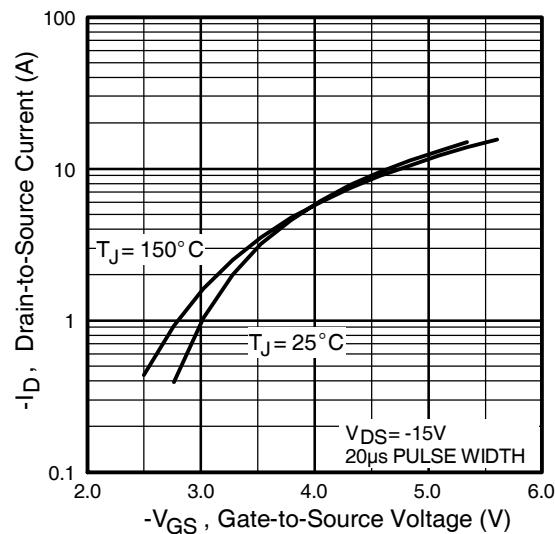
③ Surface mounted on 1 in square Cu board,  $t \leq 10\text{sec}$ .



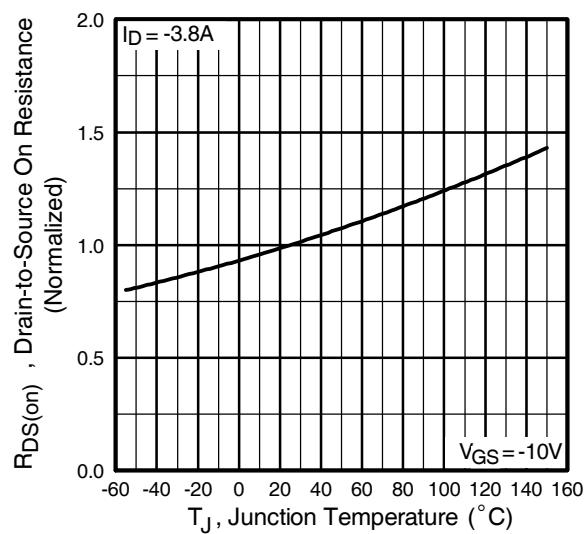
**Fig 1.** Typical Output Characteristics



**Fig 2.** Typical Output Characteristics



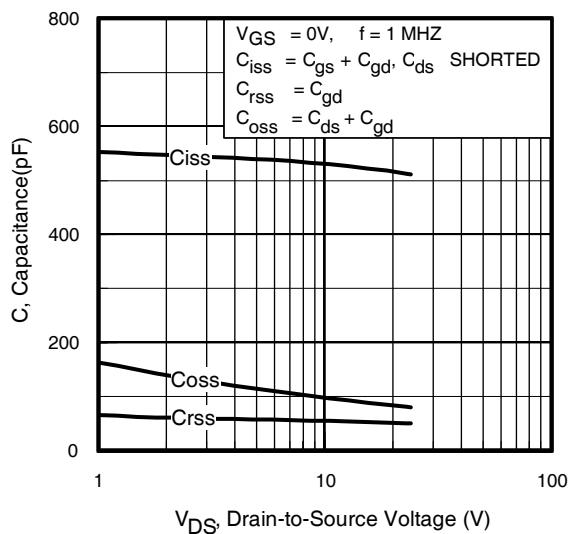
**Fig 3.** Typical Transfer Characteristics



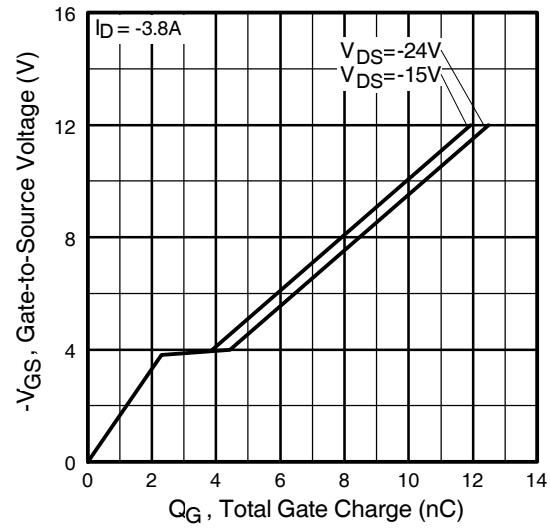
**Fig 4.** Normalized On-Resistance  
Vs. Temperature

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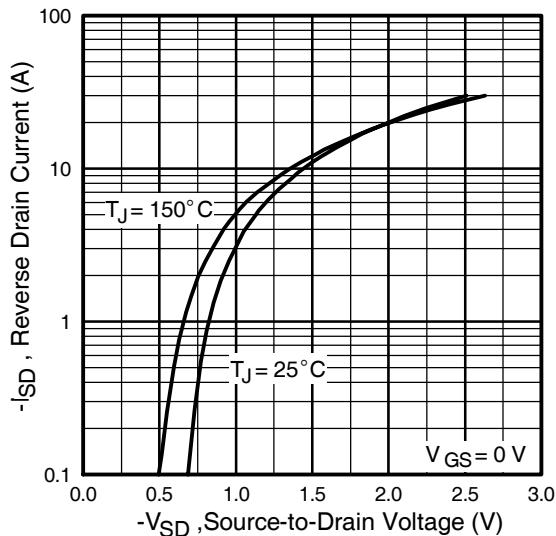
International  
**IR** Rectifier



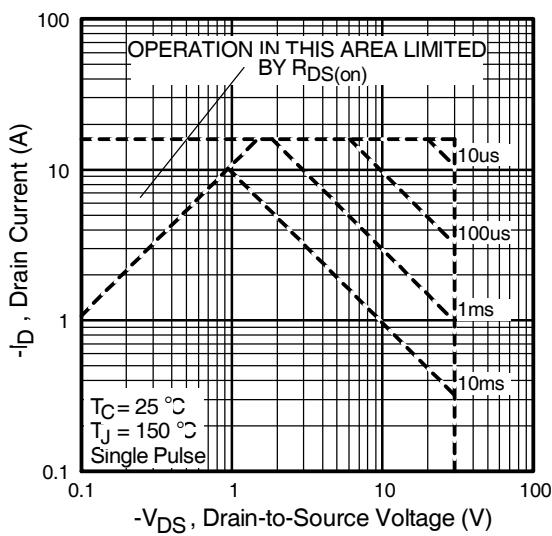
**Fig 5.** Typical Capacitance Vs.  
Drain-to-Source Voltage



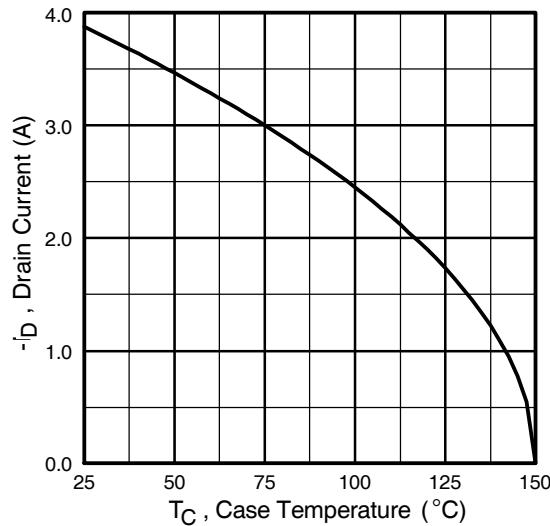
**Fig 6.** Typical Gate Charge Vs.  
Gate-to-Source Voltage



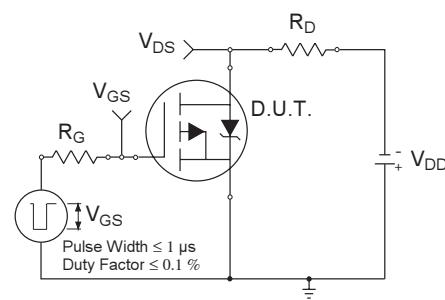
**Fig 7.** Typical Source-Drain Diode  
Forward Voltage



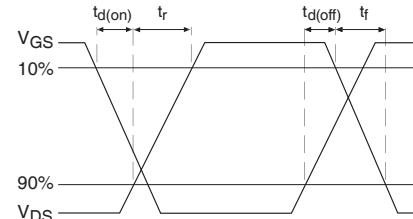
**Fig 8.** Maximum Safe Operating Area



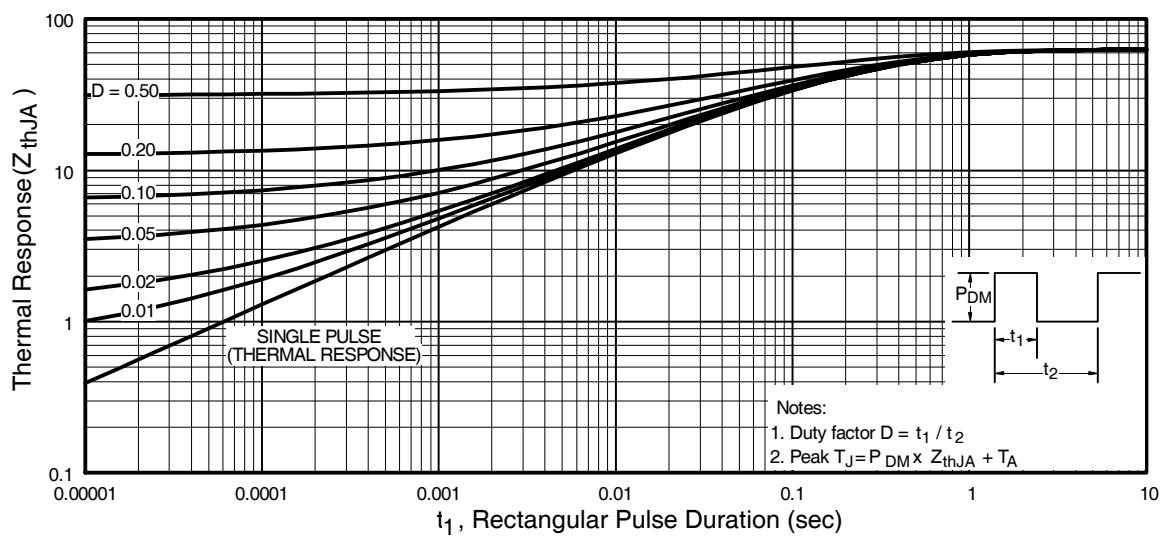
**Fig 9.** Maximum Drain Current Vs.  
Case Temperature



**Fig 10a.** Switching Time Test Circuit



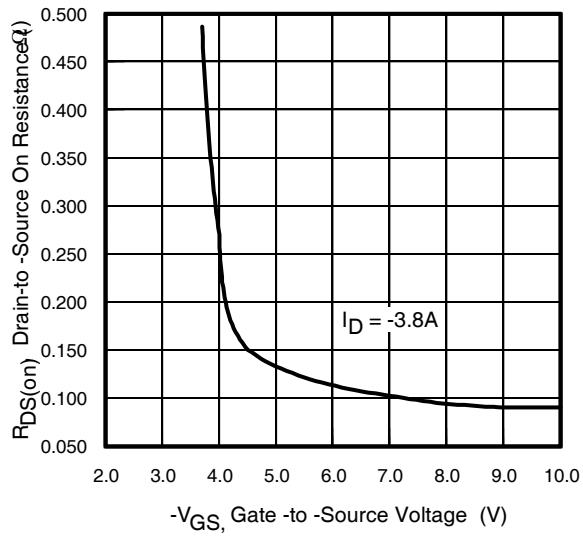
**Fig 10b.** Switching Time Waveforms



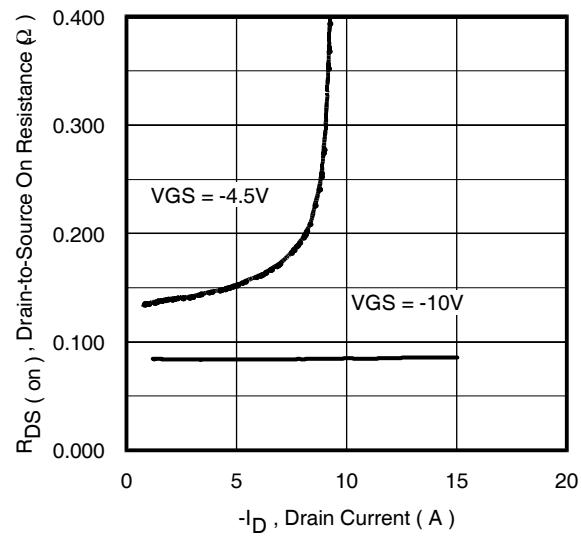
**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

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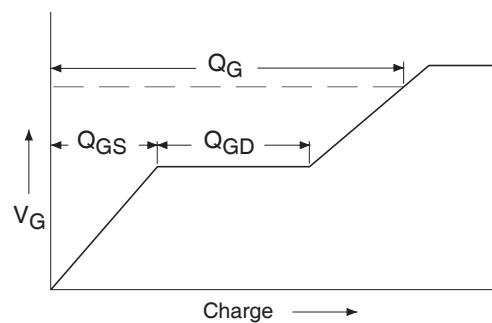
International  
**IR** Rectifier



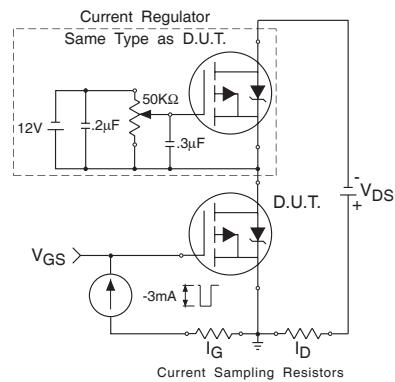
**Fig 12.** Typical On-Resistance Vs.  
Gate Voltage



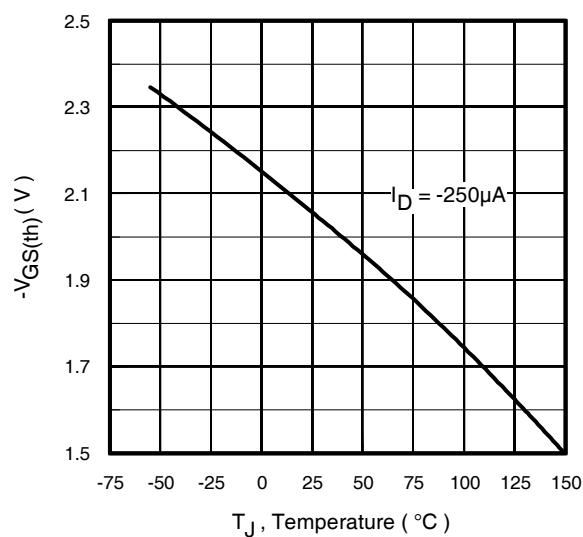
**Fig 13.** Typical On-Resistance Vs.  
Drain Current



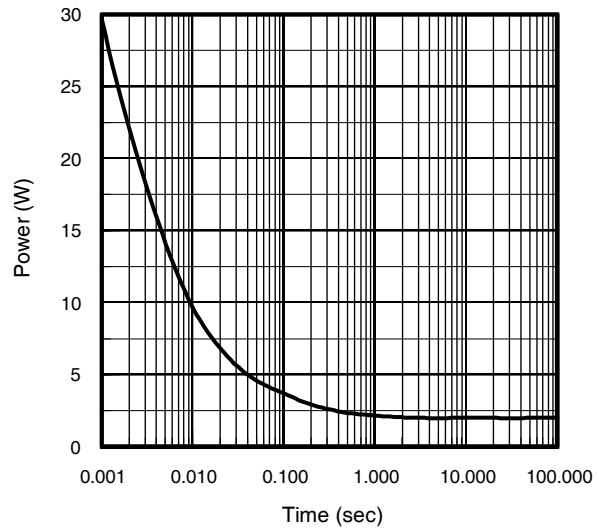
**Fig 14a.** Basic Gate Charge Waveform



**Fig 14b.** Gate Charge Test Circuit



**Fig 15.** Typical  $V_{GS(th)}$  Vs.  
Junction Temperature

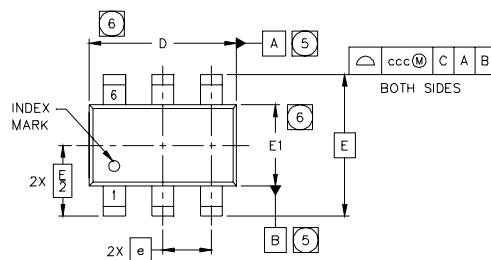


**Fig 16.** Typical Power Vs. Time

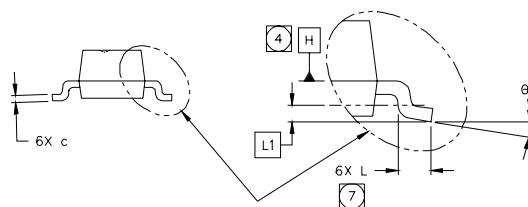
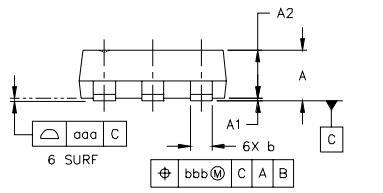
# IRF5805PbF

## TSOP-6 Package Outline

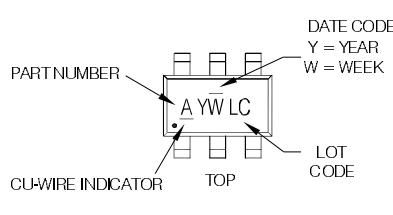
International  
IR Rectifier



| S<br>U<br>M<br>B<br>O<br>L | MO-193AA DIMENSIONS |      |      |           |       |       |
|----------------------------|---------------------|------|------|-----------|-------|-------|
|                            | MILLIMETERS         |      |      | INCHES    |       |       |
|                            | MIN                 | NOM  | MAX  | MIN       | NOM   | MAX   |
| A                          | ---                 | ---  | 1.10 | ---       | ---   | .0433 |
| A1                         | 0.01                | ---  | 0.10 | .0004     | ---   | .0039 |
| A2                         | 0.80                | 0.90 | 1.00 | .0315     | .0354 | .0393 |
| b                          | 0.25                | ---  | 0.50 | .0099     | ---   | .0196 |
| c                          | 0.10                | ---  | 0.26 | .004      | ---   | .010  |
| D                          | 2.90                | 3.00 | 3.10 | .115      | .118  | .122  |
| E                          | 2.75 BSC            |      |      | .108 BSC  |       |       |
| E1                         | 1.30                | 1.50 | 1.70 | .052      | .059  | .066  |
| e                          | 1.00 BSC            |      |      | .039 BSC  |       |       |
| L                          | 0.20                | 0.40 | 0.60 | .0079     | .0157 | .0236 |
| L1                         | 0.30 BSC            |      |      | .0118 BSC |       |       |
| θ                          | 0°                  | ---  | 8°   | 0°        | ---   | 8°    |
| aaa                        | 0.10                |      |      | .004      |       |       |
| bbb                        | 0.15                |      |      | .006      |       |       |
| ccc                        | 0.25                |      |      | .010      |       |       |



### TSOP-6 Part Marking Information



PART NUMBER CODE REFERENCE:

- A = S3443DV    K = IRF5810
- B = IRF5800    L = IRF5804
- C = IRF5850    M = IRF5803
- D = IRF5851    N = IRF5802
- E = IRF5852
- F = IRF5801
- I = IRF5805
- J = IRF5806

Notes:

- A line above the work week (as shown here) indicates Lead-Free
- A line below the part number (as shown here) indicates Cu-wire

W = (1-26) IF PRECEDED BY LAST DIGIT OF CALENDAR YEAR

| YEAR | Y | WORK WEEK | W |
|------|---|-----------|---|
| 2001 | 1 | 01        | A |
| 2002 | 2 | 02        | B |
| 2003 | 3 | 03        | C |
| 2004 | 4 | 04        | D |
| 2005 | 5 |           |   |
| 2006 | 6 |           |   |
| 2007 | 7 |           |   |
| 2008 | 8 |           |   |
| 2009 | 9 |           |   |
| 2010 | 0 | 24        | X |
|      |   | 25        | Y |
|      |   | 26        | Z |

W = (27-52) IF PRECEDED BY A LETTER

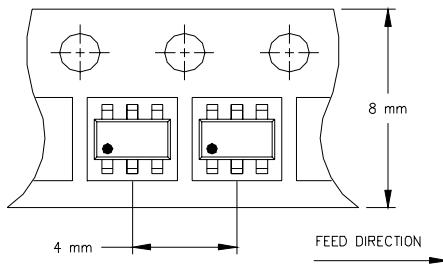
| YEAR | Y | WORK WEEK | W |
|------|---|-----------|---|
| 2001 | A | 27        | A |
| 2002 | B | 28        | B |
| 2003 | C | 29        | C |
| 2004 | D | 30        | D |
| 2005 | E |           |   |
| 2006 | F |           |   |
| 2007 | G |           |   |
| 2008 | H |           |   |
| 2009 | J |           |   |
| 2010 | K | 50        | X |
|      |   | 51        | Y |
|      |   | 52        | Z |

Note: For the most current drawing please refer to IR website at: <http://www.irf.com/package/>

International  
**IR** Rectifier

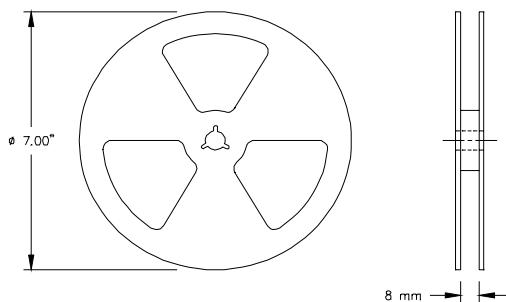
**IRF5805PbF**

## TSOP-6 Tape & Reel Information



NOTES:

1. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES:

1. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Data and specifications subject to change without notice.  
This product has been designed and qualified for the Consumer market.  
Qualifications Standards can be found on IR's Web site.

International  
**IR** Rectifier

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TAC Fax: (310) 252-7903

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